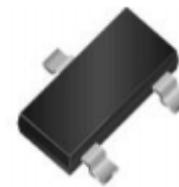


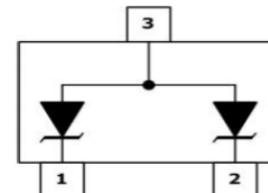
## Description

The XE23TUC5VU is a two low ultra low capacitance ESD protection array designed to protect sensitive electronic components which are connected to high speed data lines and control lines from over-stress caused by ESD (Electrostatic Discharge), EFT (Electrical Fast Transients) and Lightning. The XE23TUC5VU may be used to provide ESD protection up to  $\pm 20\text{kV}$  (contact and air) discharge according to IEC61000-4-2, and withstand peak pulse current up to 5A (8/20 $\mu\text{s}$ ) according to IEC61000-4-5. The XE23TUC5VU is available in SOT-23 package. Standard products are Pb-free and Halogen-free.

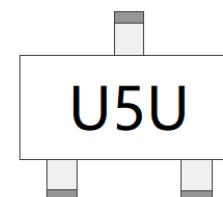
<http://www.xihangsemi.com>



**SOT-23**



## Circuit Diagram



**Marking (Top View)**

## Order Information

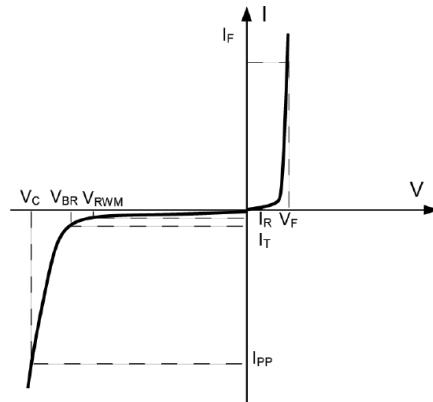
Device	Package	Shipping
XE23TUC5VU	SOT-23	3000/Tape&Reel

## Applications

- ◆ Personal digital assistants (PDA's)
- ◆ Notebooks, Desktops, and Servers
- ◆ Cell phone Handsets and Accessories
- ◆ Portable Electronics
- ◆ Peripherals

## Definitions of electrical characteristics

Symbol	Parameter
$V_{RWM}$	Reverse Stand-off Voltage
$I_R$	Reverse Leakage Current @ $V_{RWM}$
$V_{BR}$	Reverse Breakdown Voltage @ $I_T$
$I_R$	Reverse Breakdown Current
$I_{PP}$	Reverse Peak Pulse Current
$V_C$	Clamping Voltage @ $I_{PP}$



## Absolute Maximum Rating

Rating	Symbol	Value	Units
Peak Pulse Power ( $t_P = 8/20\mu S$ )	$P_{PK}$	75	W
Peak Pulse Current ( $t_P = 8/20\mu S$ )	$I_{pp}$	5	A
ESD according to IEC61000-4-2 air discharge	$V_{ESD}$	$\pm 20$	kV
ESD according to IEC61000-4-2 contact discharge		$\pm 20$	kV
Lead Soldering Temperature	$T_L$	260 (10 sec)	°C
Operating Temperature	$T_{OP}$	-55 to +125	°C
Storage Temperature	$T_{STG}$	-55 to +150	°C

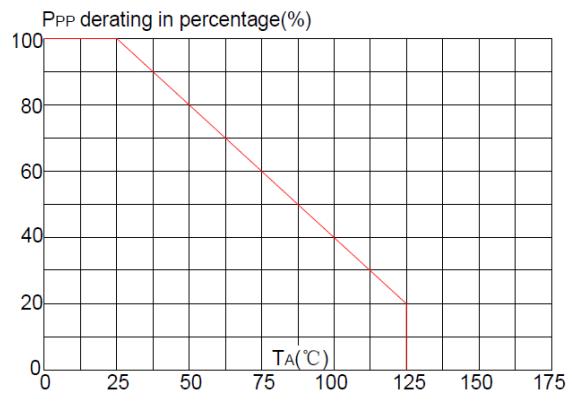
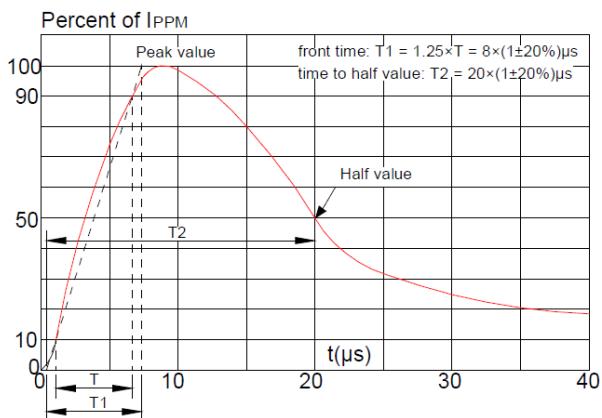
## Electrical Characteristics (Ta=25°C, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Stand-off Voltage	$V_{RWM}$				5	V
Reverse Leakage Current	$I_R$	$V_{RWM}=5V$			100	nA
Reverse Breakdown Voltage	$V_{BR}$	$I_T=1mA$	7.0	8.0	9.0	V
Clamping Voltage <sup>1)</sup>	$V_C$	$I_{PP}=1A \quad t_P = 8/20\mu s$		8.5	10	V
		$I_{PP}=5A \quad t_P = 8/20\mu s$		13	15	V
Junction Capacitance	$C_J$	$V_R=0V \quad f = 1MHz, \text{ Any I/O to GND}$		0.6	0.8	pF
		$V_R=0V \quad f = 1MHz, \text{ Between any I/O pin}$		0.3	0.4	pF

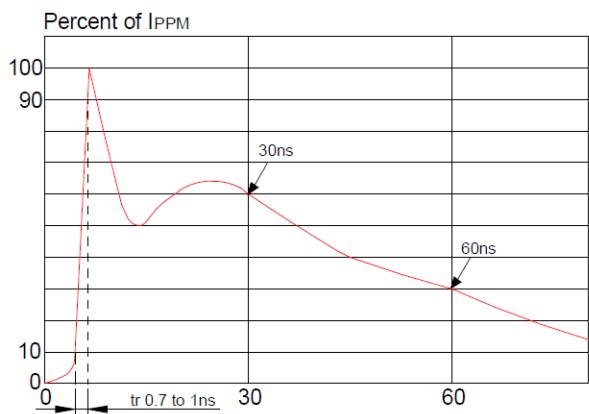
Notes:

1)Non-repetitive current pulse, according to IEC61000-4-5.

## Typical Characteristics (Ta=25°C, unless otherwise noted)

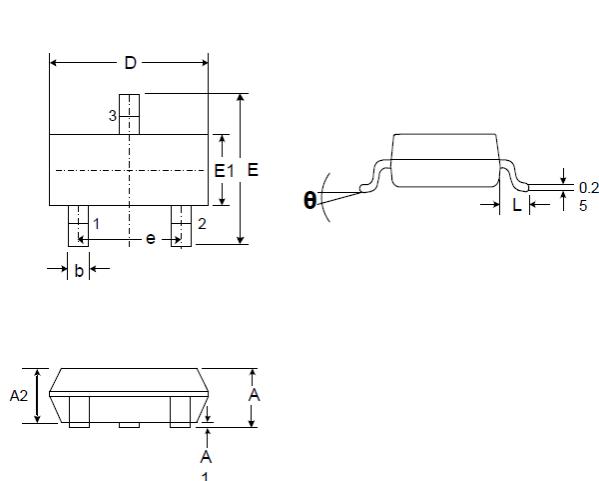


**Pulse Derating Curve**



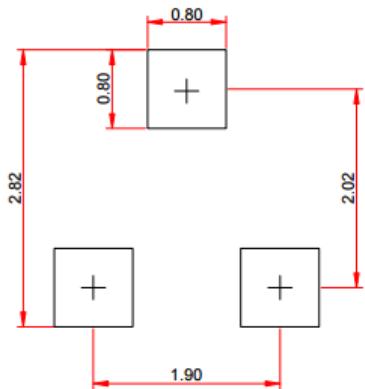
**ESD Clamping(8kV Contact Discharge )**

## Package Outline Dimensions (SOT-23)



SYMBOL	MILLIMETER		INCHES	
	MIN	MAX	MIN	MAX
A	0.89	1.12	0.035	0.044
A1	0.01	0.10	0.0006	0.00434
A2	0.88	1.02	0.035	0.040
D	2.80	3.04	0.110	0.120
E	2.10	2.64	0.082	0.104
E1	1.20	1.40	0.047	0.055
e	1.90BSC		0.75BSC	
L	0.40	0.60	0.015	0.024
θ	0	8	0	8

## Recommend Land Pattern (Unit: mm)



Note:

This recommended land pattern is for reference purpose only.

### NOTICE

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